

## Info 33 E - Precipitating Silver from rinse water

### GENERAL INFORMATION

TMT 15<sup>®</sup> is widely used in various industries that produce liquid wastes containing heavy metals. The heavy metals are usually removed from the wastewater by precipitation and flocculation.

Individual examples demonstrate the effectiveness of treatment methods in practice, and should give anyone interested enough background to perform tests to check the suitability of TMT 15<sup>®</sup> for their own particular wastewater composition. We would be happy to provide TMT 15<sup>®</sup> in sample amounts. Our Application Technology department is also prepared to provide assistance in finding solutions.

### PHOTOGRAPHIC RINSE WATER / SILVERTHIOSULFATE COMPLEX

Treatment process:

- Collect 4 l of rinse water (10 mg Ag/l, 2 g Na<sub>2</sub>S<sub>2</sub>O<sub>3</sub> x 5 H<sub>2</sub>O/l, pH 3.7),
- adjust to pH 9 using 2.4 ml of 10% caustic Soda
- within 25 minutes, add 0.26 ml of TMT 15<sup>®</sup> while stirring,
- add 2 ml ferric chloride solution (10 g Fe/l)
- add 20 ml of 0.1% strong cationic flocculation aid (such as Praestol 655 BC),
- adjust to pH 9 using 0.3 ml of 10% caustic Soda
- stir rapidly for 1 minute, slowly for 15 minutes,
- separate brown-colored, coarsely flocculent precipitate by filtering.

The filtrate only contained 0.2 mg Ag/l

## REMARKS

TMT 15<sup>®</sup> requirement: 6.4 l TMT 15<sup>®</sup> per kg Silver (Ag) in rinse water.

For Silver precipitation, it is usually necessary to adjust the pH value to the range 7–10 after the required chemicals have been added. To some extent, the precipitation result and residual metal content is strongly dependent on the pH value, depending on the type and concentration of com-plexing agents.

## EXAMPLES

TMT Info No.	Heavy metal	Complexing agent	Branch
TMT Info 30	Copper (Cu)	Tetrammine	Printed circuit board Manufacture
TMT Info 31	Copper (Cu)	EDTA complex	Printed circuit board Manufacture
TMT Info 32	Cadmium (Cd)	Tetrammine	Electroplating
TMT Info 33	Silver (Ag)	Thiosulfate complex	Photografic rinse water
TMT Info 34	Silver (Ag)	Thiosulfate complex	Photografic concentrate
TMT Info 35	Mercury (Hg)	Chlorocomplex	Chemical industry
TMT Info 36	Nickel (Ni)	Polyamine complex	Electroplating
TMT Info 37	Lead (Pb)	Cataphoretic electro-deposition of paint	Automotive industry
TMT Info 38	Copper (Cu) & Nickel (Ni)	Actual wastewater	Printed circuit board Manufacture

### Disclaimer

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